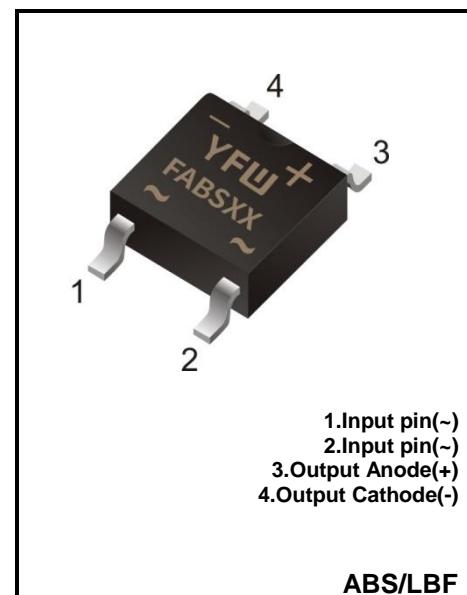


2.0A SURFACE MOUNT GLASS PASSIVATED BRIDGE
RECTIFIER Reverse Voltage - 600 to 1000 V
Forward Current – 2.0A
FEATURES

- ◆ Fast reverse recovery time
- ◆ Designed for Surface Mount Application
- ◆ Glass Passivated Chip Junction
- ◆ Low power loss, high efficiency
- ◆ Lead free in comply with EU RoHS 2011/65/EU directives


MECHANICAL DATA

- ◆ Case: ABS/LBF
- ◆ Terminals: Solderable per MIL-STD-750, Method 2026
- ◆ Approx. Weight: 88mg / 0.0031oz


Maximum Ratings and Electrical characteristics

Ratings at 25 °C ambient temperature unless otherwise specified.

Single phase half-wave 60 Hz, resistive or inductive load, for capacitive load current derate by 20 %.

Parameter	Symbols	FABS206	FABS208	FABS210	Units
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	600	800	1000	V
Maximum RMS voltage	V_{RMS}	420	560	700	V
Maximum DC Blocking Voltage	V_{DC}	600	800	1000	V
Average Rectified Output Current at $T_c = 125^\circ\text{C}$	I_o	2.0			A
Peak Forward Surge Current 8.3 ms Single Half Sine-Wave Superimposed on Rated Load(JEDEC method)	I_{FSM}	55			A
Forward Voltage per element at 2.0A	V_F	1.0			V
Maximum DC Reverse Current @ $T_A=25^\circ\text{C}$ at Rated DC Blocking Voltage @ $T_A=125^\circ\text{C}$	I_R	5.0 100			μA
Typical Junction Capacitance ^(Note1)	C_j	40			pF
Maximum Reverse Recovery Time ^(Note2) IF=0.5A,IR=1A,IRR=0.25A	T_{RR}	10			μs
I^2 rating for fusing (1ms< t <10ms)	I^2t	15			A^2s
Operating and Storage Temperature Range	T_j, T_{stg}	-55 ~ +175			°C

(1) Measured at 1 MHz and applied reverse voltage of 4 V D.C

(2) Mounted on glass epoxy PC board with 4x1.5" x 1.5" (3.81x3.81 cm) copper pad.

Fig.1 Average Rectified Output Current Derating Curve

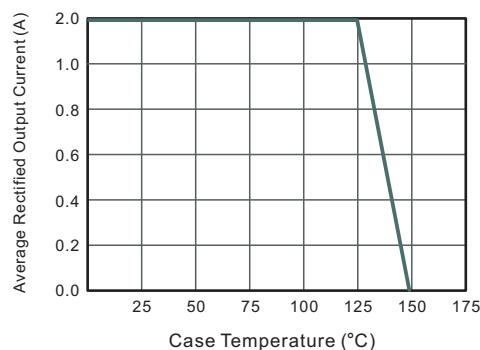


Fig.2 Typical Reverse Characteristics

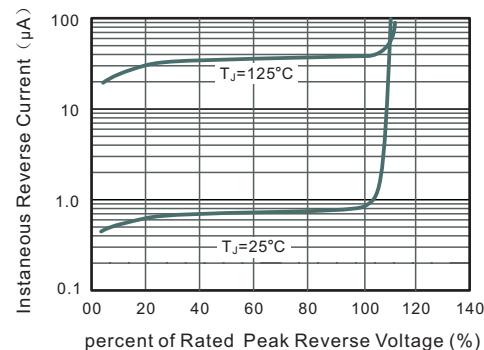


Fig.3 Typical Instantaneous Forward Characteristics

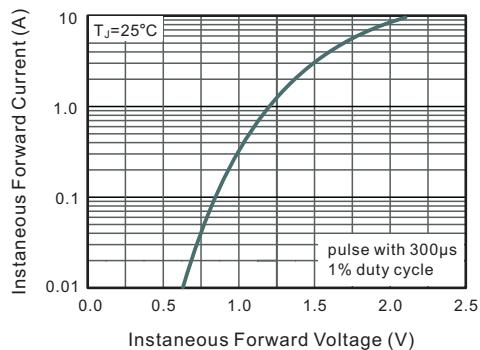


Fig.4 Typical Junction Capacitance

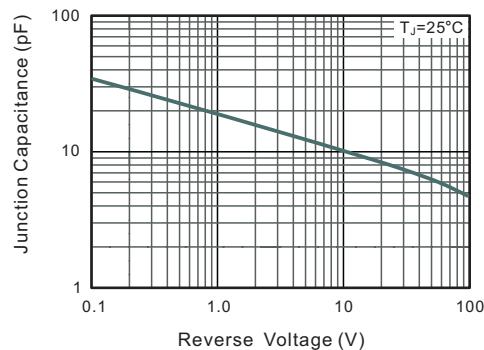
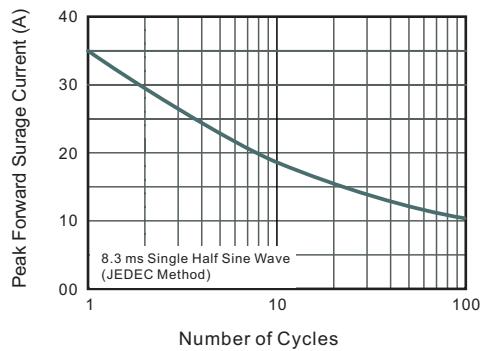
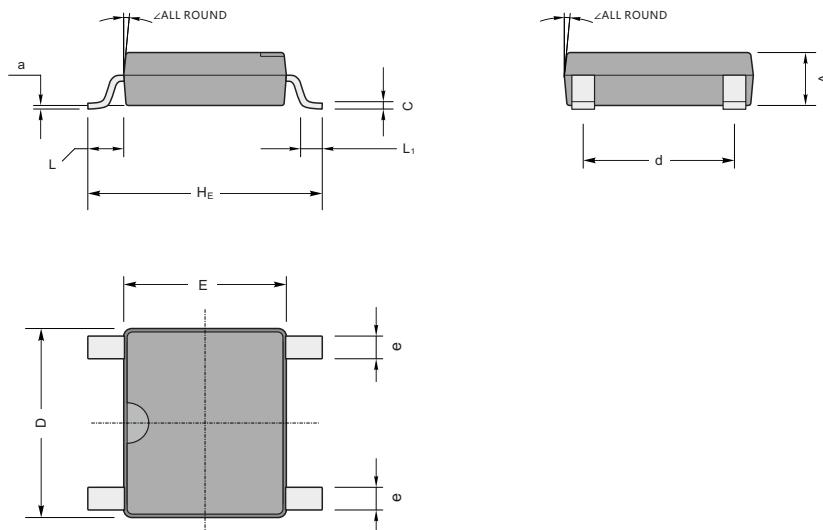
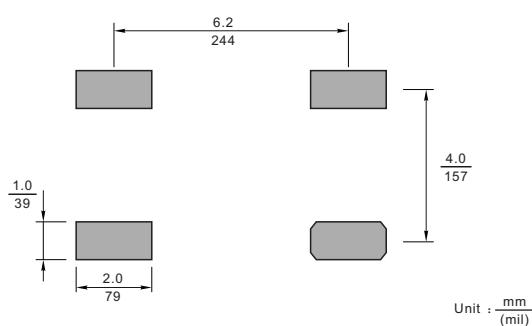


Fig.5 Maximum Non-Repetitive Peak Forward Surge Current



Package Outline
ABS/LBF
Plastic surface mounted package; 4leads


UNIT		A	C	D	E	H _E	d	e	L	L ₁	a	∠	
mm	max	1.5	0.22	5.2	4.5	6.4	4.2	0.7	0.95	0.6	0.2	7°	
	min	1.3	0.15	4.9	4.2	6.0	3.8	0.5					
mil	max	59	8.7	205	177	252	165	28	37	24	8		
	min	51	5.9	193	166	236	150	20					

The recommended mounting pad size

Summary of Packing Options

Package	Packing Description	Packing Quantity	Industry Standard
ABS/LBF	Tape/Reel,13"reel	5000	EIA-481-1